

Technical Data Green Products

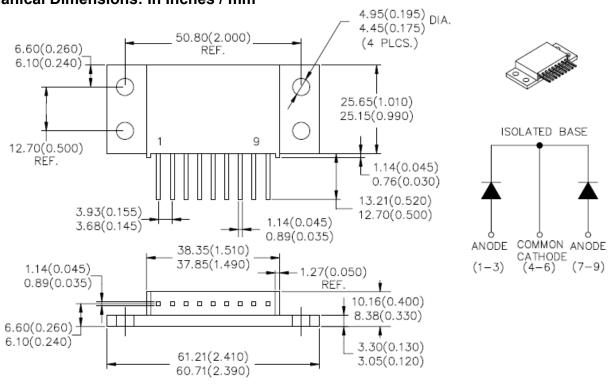
Data Sheet N1182, Rev. -

159CMQ135/159CMQ150 SCHOTTKY RECTIFIER

Applications:

- Switching power supply Converters Free-Wheeling diodes Reverse battery protection Features:
 - 175 °C T_J operation
 - Isolated heatsink
 - Multiple leads per terminal for high frequency, high current PC board mounting
 - · Low profile, high current package
 - Center tap module
 - Low forward voltage drop
 - High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
 - High frequency operation
 - · Guard ring for enhanced ruggedness and long term reliability
 - This is a Pb Free Device
 - All SMC parts are traceable to the wafer lot
 - Additional testing can be offered upon request

Mechanical Dimensions: In Inches / mm



TO-249(9 pin)

MARKING, MOLDING RESIN

Marking for 159CMQ135/150, 1^{st} row SS YYWWL, 2^{nd} row 159CMQ135/150, 3^{rd} row $1\ 2\ 3$ (Pin) Where YY is the manufacture year

WW is the manufacture week code L is the wafer's Lot Number

Molding resin

Epoxy resin UL:94V-0

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Maximum Ratings:

Characteristics	Symbol	Condition		Max.	Units
Peak Inverse Voltage	Vrwm	-	135	159CMQ135	V
			150	159CMQ150	
Max. Average Forward*	I _{F(AV)}	50% duty cycle @T _C = 90°C, rectangular wave form		150	А
Max. Peak One Cycle Non- Repetitive Surge Current (peg leg)	I _{FSM}	8.3 ms, half Sine pulse		864	А

Electrical Characteristics:

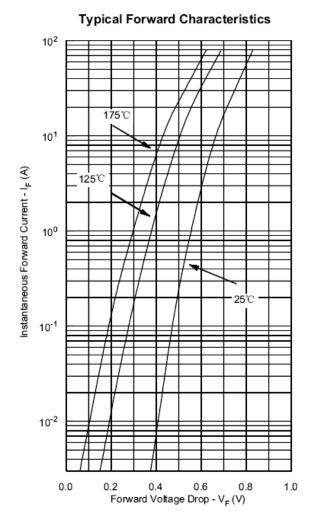
Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop (per leg) *	V_{F1}	@ 80A, Pulse, T _J = 25 °C	1.05	V
	V_{F2}	@ 80A, Pulse, T _J = 125 °C	0.85	V
Max. Reverse Current (per leg) *	I_{R1}	$@V_R = \text{rated } V_R T_J = 25 ^{\circ}\text{C}$	1.5	mΑ
	I_{R2}	$@V_R = \text{rated } V_R, T_J = 125 ^{\circ}\text{C}$	21	mΑ
Max. Junction Capacitance (per leg)	Ст	$@V_R = 5V, T_C = 25 °C$ $f_{SIG} = 1MHz$	1300	pF

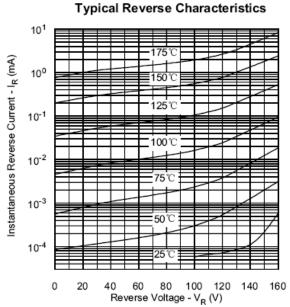
^{*} Pulse Width < 300µs, Duty Cycle <2%

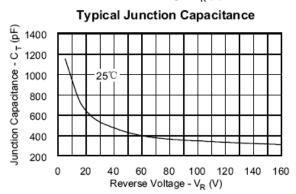
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units		
Max. Junction Temperature	T_J	-	-55 to +175	°C		
Max. Storage Temperature	T_{stg}	-	-55 to +175	°C		
Maximum Thermal Resistance Junction to Case (per leg)	$R_{ heta JC}$	DC operation	1.0	°C/W		
Maximum Thermal Resistance Junction to Case (per package)	$R_{ heta JC}$	DC operation	0.50	°C/W		
Typical Thermal Resistance, case to Heat Sink	$R_{\theta cs}$	Mounting surface, smooth and greased	0.10	°C/W		
Mounting Torque	Тм	-	40(min)	- Kg-cm		
			58(max)			
Approximate Weight	wt	-	56	g		
Case Style	TO-249(9 pin)					

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159CMQ...SERIES

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